

Innovating Energy Technology

FML60N118S2FDHF

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FUJI POWER MOSFET

Super J MOS® S2 series

N-Channel enhancement mode power MOSFET

Features

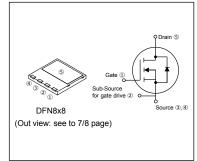
Pb-free lead terminal RoHS compliant Halogen-free molding compound MSL:1, Reflow available

Applications

For switching



Package and Internal circuit chart



■ Absolute Maximum Ratings at T_c=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Dunin Course Voltage	V DS	600	V	
Drain-Source Voltage	V _{DSX}	600	V	V _{GS} =-30V
Continuous Dunin Comment	,	37.1	Α	<i>T</i> _c =25°C Note*1,2
Continuous Drain Current	I □	23.5	Α	Tc=100°C Note*1,2
Pulsed Drain Current	I DP	108.0	Α	Note *2
Gate-Source Voltage	V _{GS}	±30	V	
Non-Repetitive Maximum Avalanche Current	I AS	4.4	А	Note *3
Non-Repetitive Maximum Avalanche Energy	E AS	708.1	mJ	Note *4
Maximum MOSFET dv/dt	d <i>v</i> ⊳s/d <i>t</i>	50	V/ns	V _{DS} ≤ 600V
Continuous	I DR	37.1	Α	<i>T</i> _c =25°C Note*1,2
Diode Forward Current	IDR	23.5	Α	T _c =100°C Note*1,2
Pulsed Diode Forward Current	I DRP	108.0	Α	Note *2
Peak Diode Recovery dv/dt	d <i>v</i> /d <i>t</i>	30	V/ns	Note *5
Peak Diode Recovery -dipr/dt	-di _{DR} /dt	100	A/µs	Note *6
Marrian Danier Discination	Ptot	208	W	<i>T</i> _c =25°C
Maximum Power Dissipation	Ftot	2.78	W	<i>T</i> _a =25°C
Operating Channel Temperature	T ch	150	°C	
Storage Temperature	T _{stg}	-55 to +150	°C	

Note *1 : Maximum duty cycle D=0.55

Note 1. Maximum duty cycle D=0.50 Note *2 : Limited by maximum channel temperature. Note *3 : Tot \leq 150 °C, See Figure 1 and 2. Note *4 : Starting $T_{ch} = 25$ °C, $I_{AS} = 2.7$ A, L = 178 mH, $V_{DD} = 60$ V, $R_{C} = 50$ Ω , See Figure 1 and 2. Eas limited by maximum channel temperature and avalanche current.

Note *5 : I or $\le 29.2 \text{ A}$, -d ins/d1 $\le 30 \text{ V/ns}$, V0 $\le p$ eak $\le 600 \text{ V}$, Tch $\le 150 \text{ °C}$. Note *6 : I or $\le 29.2 \text{ A}$, -d ins/d1 $\le 30 \text{ V/ns}$, V0 $\le p$ eak $\le 600 \text{ V}$, Tch $\le 150 \text{ °C}$.

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■ Electrical Characteristics at *T*_c=25°C (unless otherwise specified) • Static characteristics

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V I _D = 250 μA		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$ $I_D = 4.4 \text{ mA}$		3.0	4.0	5.0	V
Zero Gate Voltage Drain Current	Ibss	V _{DS} = 600 V V _{GS} = 0 V	T _{ch} = 25 °C	-	-	25	μΑ
		V _{DS} = 480 V V _{GS} = 0 V	T _{ch} = 125 °C	-	-	250	
Gate-Source Leakage Current	I GSS	V _{DS} = 0 V V _{GS} = ± 30 V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	V _{es} = 10 V I _D = 7.3 A		-	0.105	0.118	Ω
Gate resistance	r _g	f = 1 MHz, open drain		-	7.8	-	Ω

• Dynamic characteristics

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Transconductance	g fs	V _{DS} = 25 V I _D = 14.6 A	5.2	21	-	S
Input Capacitance	Ciss	V _{DS} = 400 V	-	1540	-	
Output Capacitance	Coss	V _{GS} = 0 V	-	55	-	
Reverse Transfer Capacitance	Crss	f = 250 kHz	-	7.4	-	
Effective output capacitance, energy related (Note *7)	C _{o(er)}	V _{DS} = 0400 V V _{GS} = 0 V	-	126	-	pF
Effective output capacitance, time related (Note *8)	C _{o(tr)}	$V_{DS} = 0400 \text{ V}$ $V_{GS} = 0 \text{ V}$ $I_D = \text{constant}$	-	511	-	
Turn-On Time	t _{d(on)}	V_{DD} = 400 V, V_{GS} = 10 V I_D = 14.6 A,	-	36	-	
	t r		-	32	-	
Turn-Off Time	t _{d(off)}	$R_{\rm G}$ = 24 Ω See Figure 3 and 4	-	226	-	ns
	t f		-	23	-	
Total Gate Charge	Q _G	$V_{DD} = 400 \text{ V}, V_{GS} = 10 \text{ V}$	-	75	-	
Gate-Source Charge	Q _{GS}	$I_b = 29.2 \text{ A}$ See Figure 5	-	26	-	nC
Gate-Drain Charge	Q GD		-	42	-	

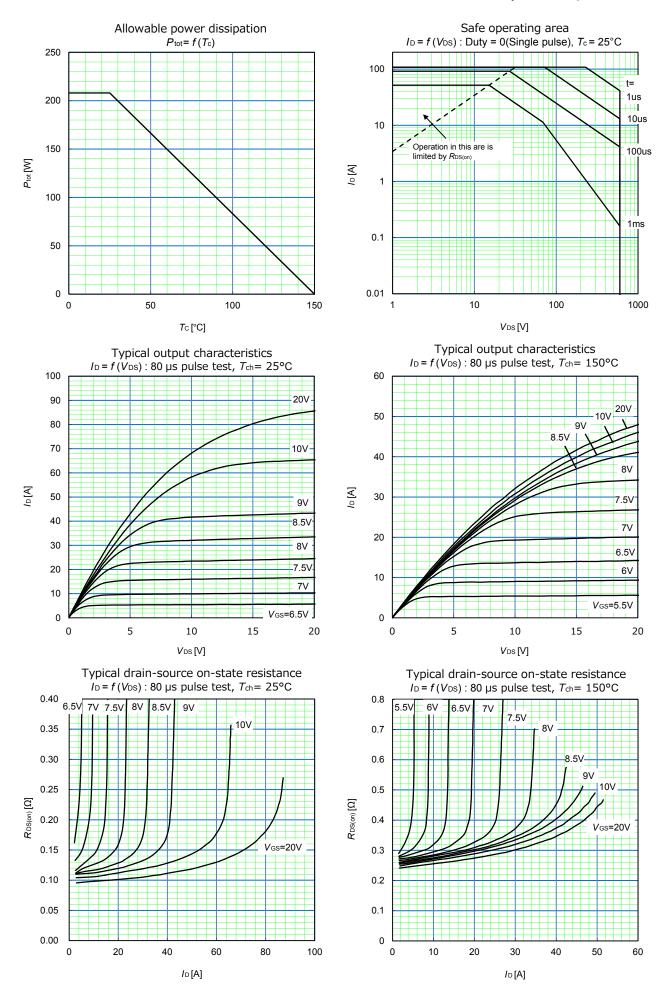
Note *7 : $C_{0(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while Vos is rising from 0 to 400V. Note *8 : $C_{o(er)}$ is a fixed capacitance that gives the same charging times as C_{oss} while Vos is rising from 0 to 400V.

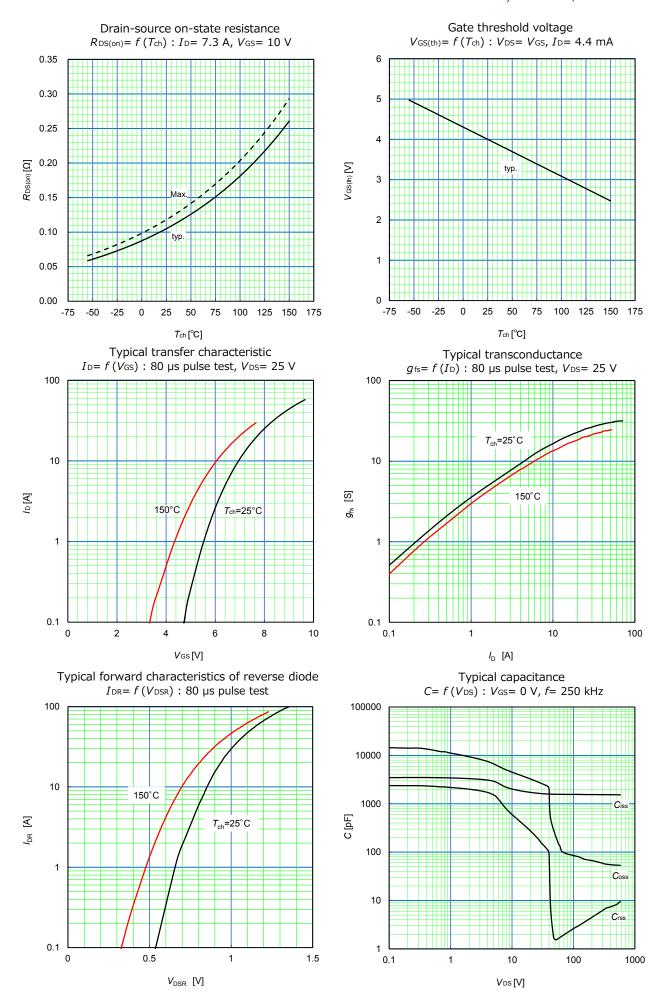
• Reverse diode characteristics

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Diode Forward On-Voltage	V _{DSR}	I _{DR} = 29.2 A, V _{GS} = 0 V T _{ch} = 25 °C	-	1.00	1.35	V
Reverse Recovery Time	t rr	V _{DD} = 400 V I _{DR} = 29.2 A V _{GS} = 0 V -di _{DR} /dt = 100 A/µs T _{ch} = 25 °C See Figure 6 and 7	-	174	-	ns
Reverse Recovery Charge	Qrr		-	1.4	-	μC
Peak Reverse Recovery Current	I rrm		-	14.9	-	Α

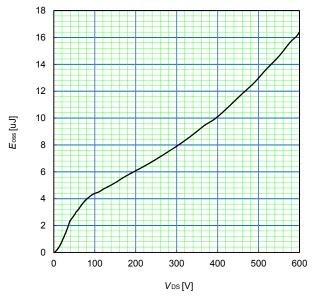
■ Thermal Resistance

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Thermal Resistance, Channel – Ambient	R _{th(ch-a)}	Device mounted on PCB (FR4) Size: 40mm*40mm*1.5mm with 6cm² copper area (one layer, 70µm thickness) for drain connection and cooling.	-	-	45	°C/W
Thermal Resistance, Channel – Case	R _{th(ch-c)}		-	-	0.601	°C/W

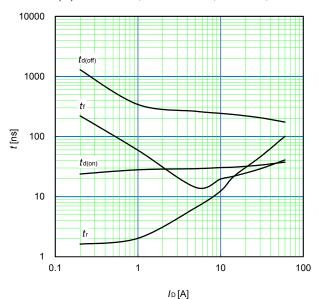




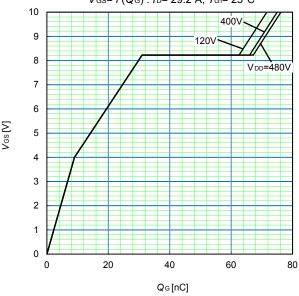




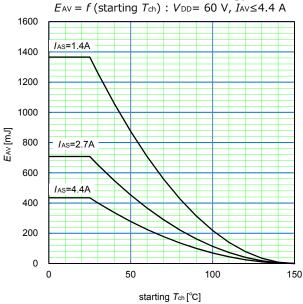
Typical switching times vs. I_D $t = f(I_D)$: $V_{DD} = 400 \text{ V}$, $V_{GS} = 10 \text{ V/0 V}$, $R_G = 24 \Omega$, $T_{Ch} = 25^{\circ}\text{C}$



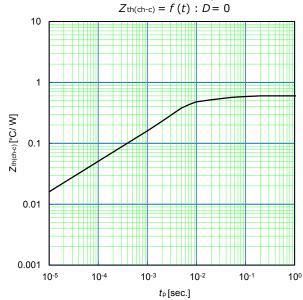
Typical gate charge $V_{GS} = f(Q_G)$: $I_D = 29.2$ A, $T_{Ch} = 25$ °C



Maximum Avalanche Energy $F_{AV} = f(\text{starting } T_{Ch}) : V_{DD} = 60 \text{ V} I_{AV} < 4.4$



Transient Thermal Impedance



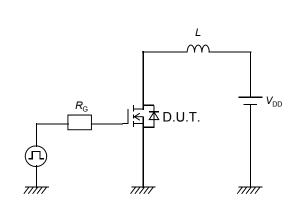


Figure 1. Unclamped inductive load test circuit

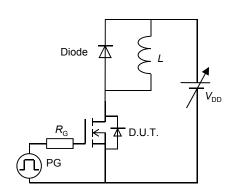


Figure 3. Switching test circuit

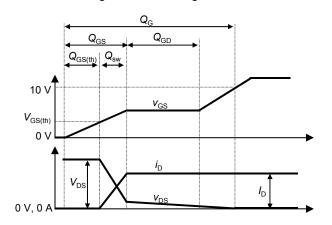


Figure 5. Gate charge waveform

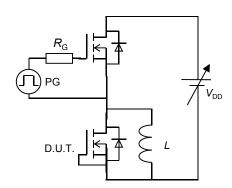


Figure 6. Diode reverse recovery test circuit

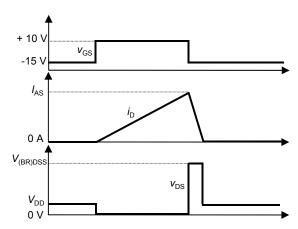


Figure 2. Unclamped inductive waveform

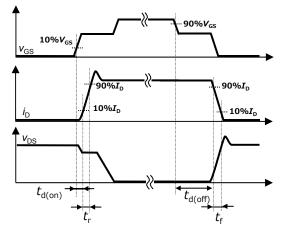


Figure 4. Switching times waveform

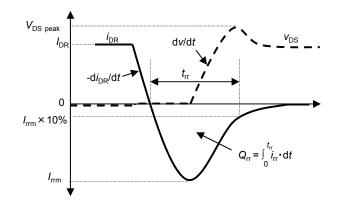
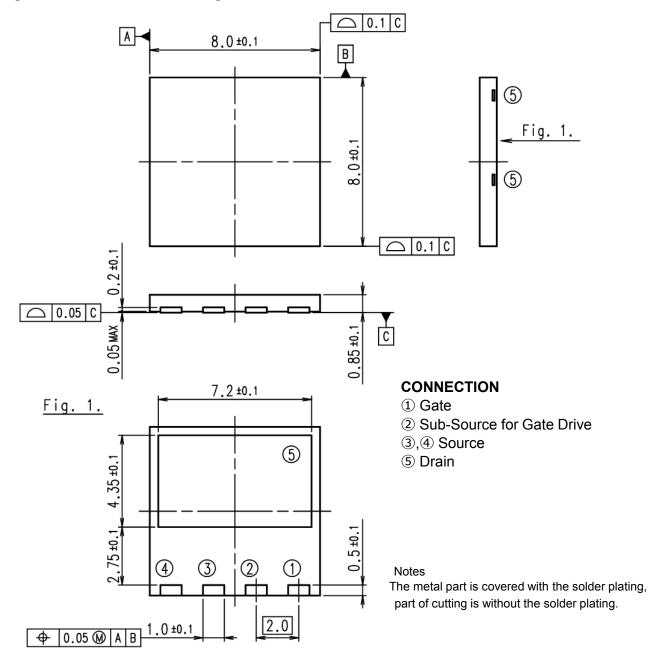
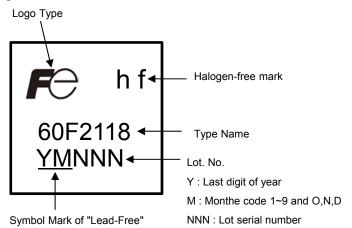


Figure 7. Diode reverse recovery waveform

■ Package Dimensions : DFN8x8 Package

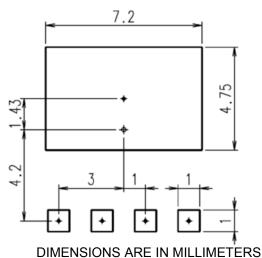


Marking



^{*} The font (font type,size) and the trademark-size might be actually different.

Recommended footprint



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